

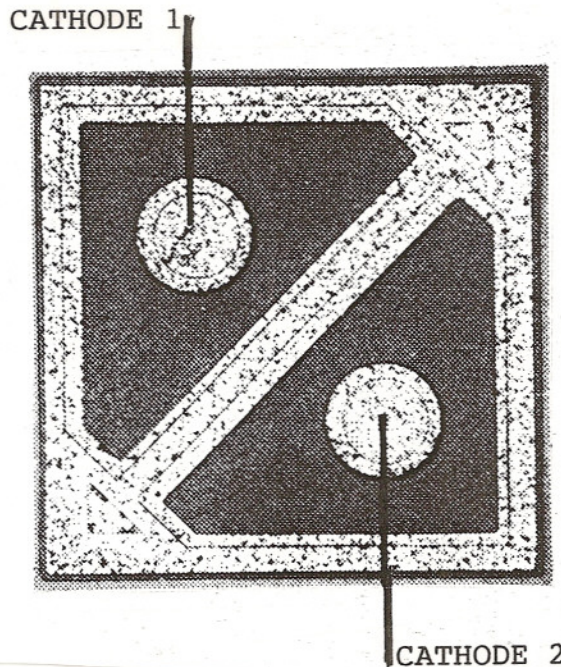


# Sierra Components, Inc.

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Chip back potential is the level which bulk silicon is maintained by on-chip connection, or it is the level to which the chip back must be connected when specifically stated below. If no potential is given the chip back should be isolated.



CHIP BACK IS COMMON ANODE

NOTE: In some databooks this geometry was numbered G32 and G37.

Topside Metal: -  
Backside: -  
Backside Potential: -  
Mask Ref: -  
Bond Pads: -

APPROVED BY:

MFG: Zetex

DIE SIZE: .022" x .022"

THICKNESS: -

DATE: 7/24/02

P/N: FD2RA